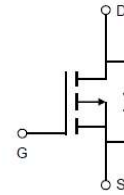


# APG52P10K

## P-Channel Enhancement Mosfet

### Features

- -100V, -35A  
 $R_{DS(ON)} < 52m\Omega @ V_{GS} = -10V$  TYP:40m $\Omega$   
 $R_{DS(ON)} < 62m\Omega @ V_{GS} = -4.5V$  TYP:44m $\Omega$
- Advanced Split Gate Trench Technology
- Excellent RDS(ON) and Low Gate Charge
- Lead free product is acquired



Schematic Diagram



Marking and pin assignment

### Applications

- Load Switch
- PWM Application
- Power management

### Package Marking and Ordering Information

| Device Marking | Device    | Device Package | Reel Size | Tape width | Quantity (PCS) |
|----------------|-----------|----------------|-----------|------------|----------------|
| G52P10K        | APG52P10K | TO-252         | 13inch    | -          | 2500           |

### ABSOLUTE MAXIMUM RATINGS ( $T_a = 25^\circ\text{C}$ unless otherwise noted)

| Parameter   | Symbol          | Value     | Unit                      |
|---|-----------------|-----------|---------------------------|
| Drain-Source Voltage                                    | $V_{DS}$        | -100      | V                         |
| Gate-Source Voltage                                     | $V_{GS}$        | $\pm 20$  | V                         |
| Continuous Drain Current ( $T_c = 25^\circ\text{C}$ )   | $I_D$           | -35       | A                         |
| Continuous Drain Current ( $T_c = 100^\circ\text{C}$ )  | $I_D$           | -23       | A                         |
| Pulsed Drain Current <sup>(1)</sup>                     | $I_{DM}$        | -140      | A                         |
| Single Pulsed Avalanche Energy <sup>(2)</sup>           | $E_{AS}$        | 87        | mJ                        |
| Drain Power Dissipation                                 | $P_D$           | 140       | W                         |
| Thermal Resistance from Junction to Case <sup>(2)</sup> | $R_{\theta JC}$ | 1.1       | $^\circ\text{C}/\text{W}$ |
| Junction Temperature                                    | $T_J$           | 150       | $^\circ\text{C}$          |
| Storage Temperature                                     | $T_{STG}$       | -55~ +150 | $^\circ\text{C}$          |

**MOSFET ELECTRICAL CHARACTERISTICS(T<sub>a</sub>=25°C unless otherwise noted)**

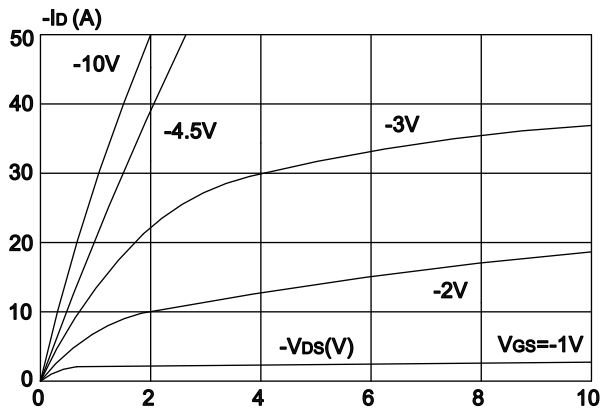
| Parameter                                 | Symbol               | Test Condition  | Min  | Type  | Max  | Unit |
|---|----------------------|---|------|-------|------|------|
| <b>Static Characteristics</b>             |                      |   |      |       |      |      |
| Drain-source breakdown voltage            | V <sub>(BR)DSS</sub> | V <sub>GS</sub> = 0V, I <sub>D</sub> = -250μA   | -100 | -     | -    | V    |
| Zero gate voltage drain current           | I <sub>DSS</sub>     | V <sub>DS</sub> = -100V, V <sub>GS</sub> = 0V   | -    | -     | -1   | μA   |
| Gate-body leakage current                 | I <sub>GSS</sub>     | V <sub>GS</sub> = ±20V, V <sub>DS</sub> = 0V  | -    | -     | ±100 | nA   |
| Gate threshold voltage                    | V <sub>GS(th)</sub>  | V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = -250μA                                 | -1.0 | -1.6  | -2.5 | V    |
| Drain-source on-resistance <sup>(3)</sup> | R <sub>DS(on)</sub>  | V <sub>GS</sub> = -10V, I <sub>D</sub> = -20A   | -    | 40    | 52   | mΩ   |
|   |                      | V <sub>GS</sub> = -4.5V, I <sub>D</sub> = -10A  |      | 44    | 62   |      |
| <b>Dynamic characteristics</b>            |                      |   |      |       |      |      |
| Input Capacitance                         | C <sub>iss</sub>     | V <sub>DS</sub> = -50V, V <sub>GS</sub> = 0V, f = 1.0MHz                                    | -    | 2120  | -    | pF   |
| Output Capacitance                        | C <sub>oss</sub>     |   | -    | 194   | -    |      |
| Reverse Transfer Capacitance              | C <sub>rss</sub>     |   | -    | 13    | -    |      |
| <b>Switching characteristics</b>          |                      |   |      |       |      |      |
| Turn-on delay time                        | t <sub>d(on)</sub>   | V <sub>DD</sub> = -50V, I <sub>D</sub> = -5A,<br>R <sub>G</sub> = 6Ω, V <sub>G</sub> = -10V | -    | 13    | -    | ns   |
| Turn-on rise time                         | t <sub>r</sub>       |   | -    | 39    | -    |      |
| Turn-off delay time                       | t <sub>d(off)</sub>  |   | -    | 100.1 | -    |      |
| Turn-off fall time                        | t <sub>f</sub>       |   | -    | 105.3 | -    |      |
| Total Gate Charge                         | Q <sub>g</sub>       | V <sub>DS</sub> = -50V, I <sub>D</sub> = -5A,<br>V <sub>GS</sub> = -10V                     | -    | 40    | -    | nC   |
| Gate-Source Charge                        | Q <sub>gs</sub>      |   | -    | 7.8   | -    |      |
| Gate-Drain Charge                         | Q <sub>gd</sub>      |   | -    | 8.6   | -    |      |
| <b>Source-Drain Diode characteristics</b> |                      |   |      |       |      |      |
| Diode Forward voltage <sup>(a)</sup>      | V <sub>SD</sub>      | T <sub>J</sub> = 25°C, V <sub>GS</sub> = 0V, I <sub>S</sub> = -30A                          | -    | -     | -1.2 | V    |
| Diode Forward current                     | I <sub>S</sub>       | T <sub>C</sub> = 25°C   | -    | -     | -35  | A    |
| Body Diode Reverse Recovery Time          | t <sub>rr</sub>      | T <sub>J</sub> = 25°C, I <sub>F</sub> = -5A, di/dt = 100A/us                                |      | 104   |      | ns   |
| Body Diode Reverse Recovery Charge        | Q <sub>rr</sub>      | T <sub>J</sub> = 25°C, I <sub>F</sub> = -5A, di/dt = 100A/us                                |      | 280   |      | uc   |

**Notes:**

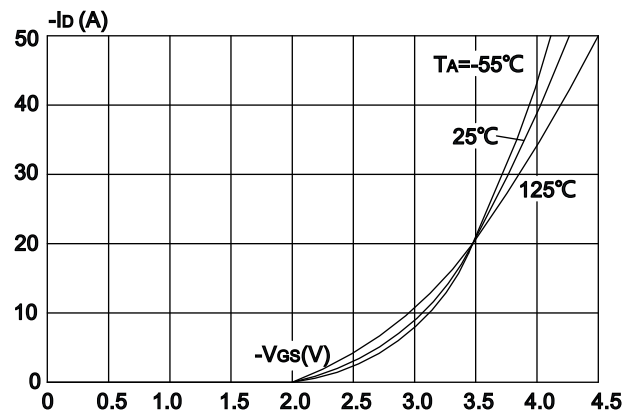
- a) Repetitive Rating: Pulse Width Limited by Maximum Junction Temperature
- b) EAS condition: T<sub>J</sub> = 25°C, V<sub>DD</sub> = -50V, V<sub>G</sub> = -10V, R<sub>G</sub> = 25Ω, L = 0.5mH, I<sub>AS</sub> = -18.7A
- c) Pulse Test: Pulse Width ≤ 300μs, Duty Cycle ≤ 0.5%

## Typical Performance Characteristics

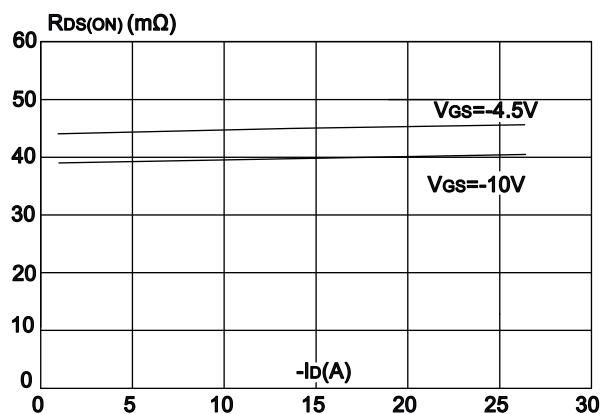
**Figure 1: Output Characteristics**



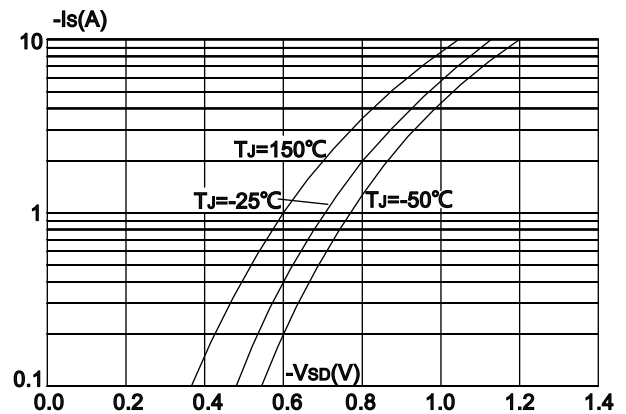
**Figure 2: Typical Transfer Characteristics**



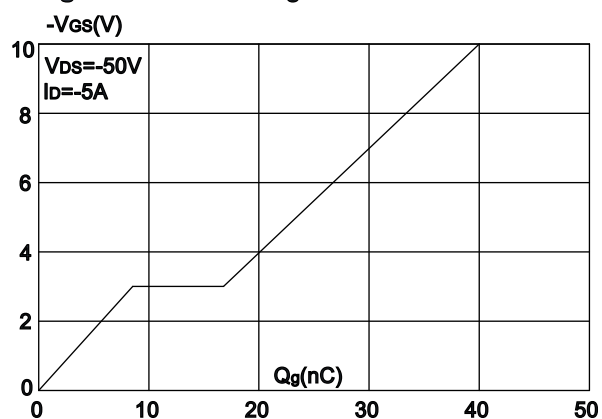
**Figure 3: On-resistance vs. Drain Current**



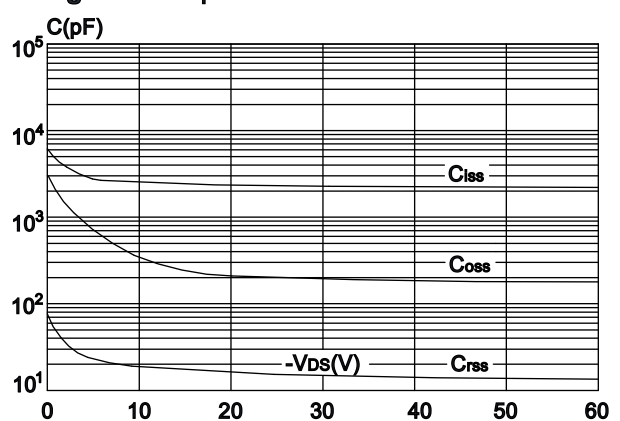
**Figure 4: Body Diode Characteristics**



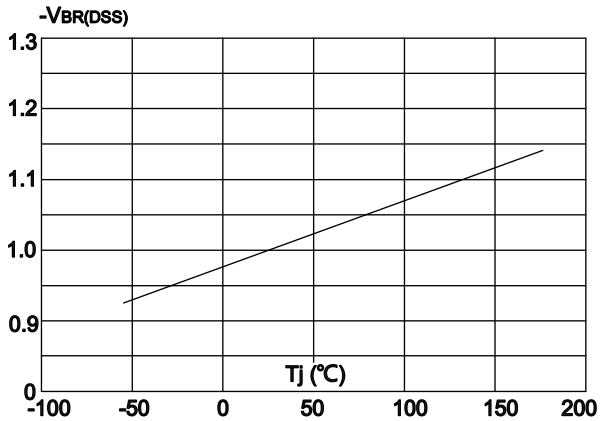
**Figure 5: Gate Charge Characteristics**



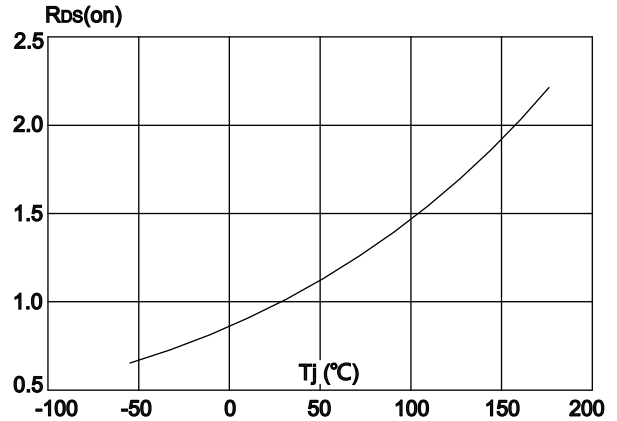
**Figure 6: Capacitance Characteristics**



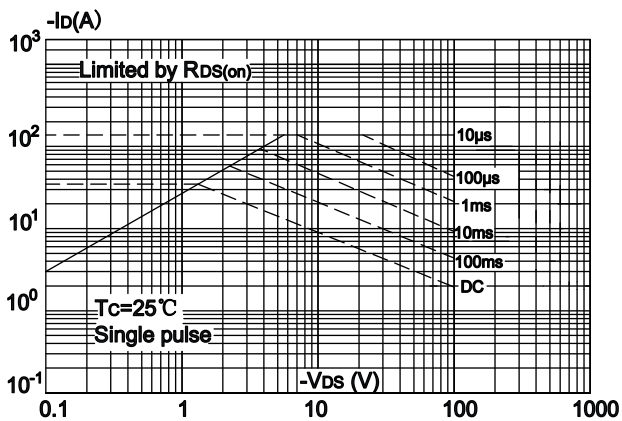
**Figure 7: Normalized Breakdown Voltage vs. Junction Temperature**



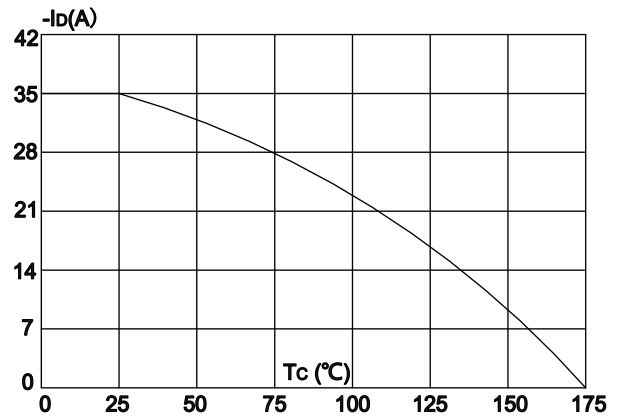
**Figure 8: Normalized on Resistance vs. Junction Temperature**



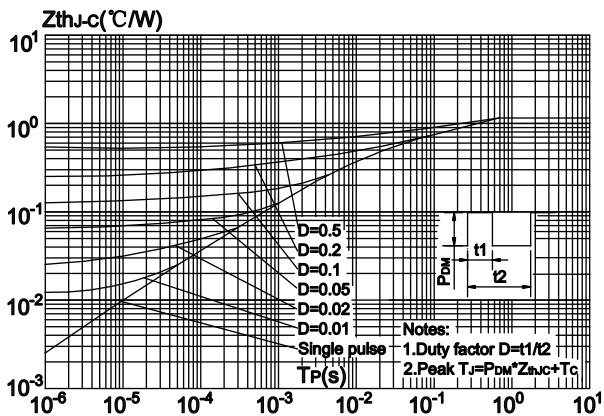
**Figure 9: Maximum Safe Operating Area**



**Figure 10: Maximum Continuous Drain Current vs. Case Temperature**



**Figure.11: Maximum Effective Transient Thermal Impedance, Junction-to-Case**



**Test Circuit**

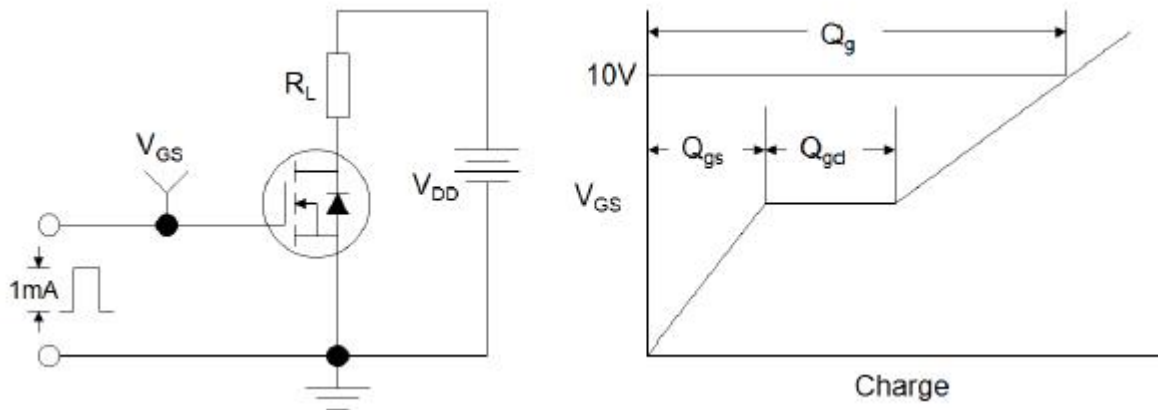


Figure1:Gate Charge Test Circuit & Waveform

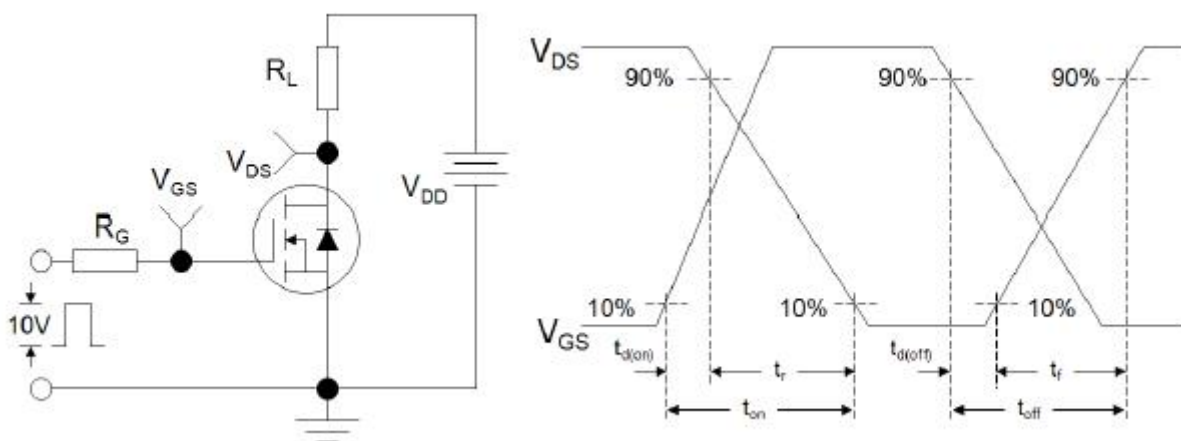


Figure 2: Resistive Switching Test Circuit & Waveforms

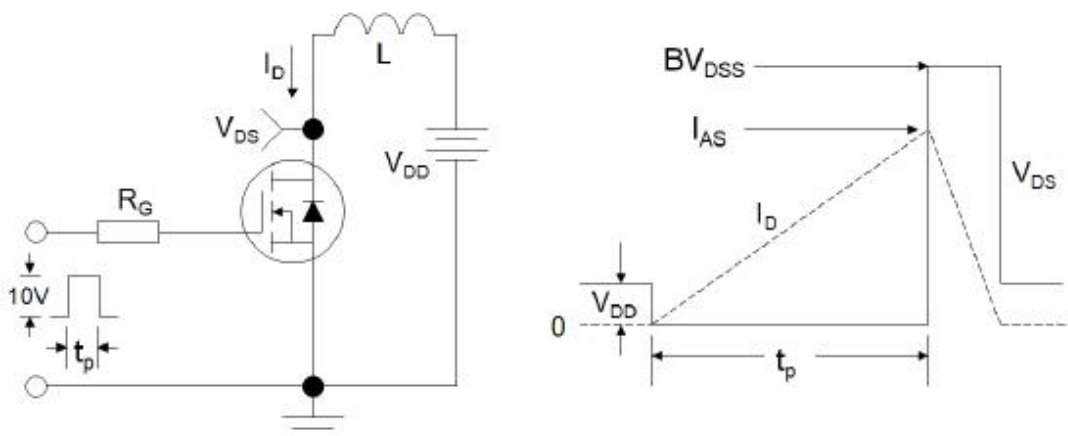
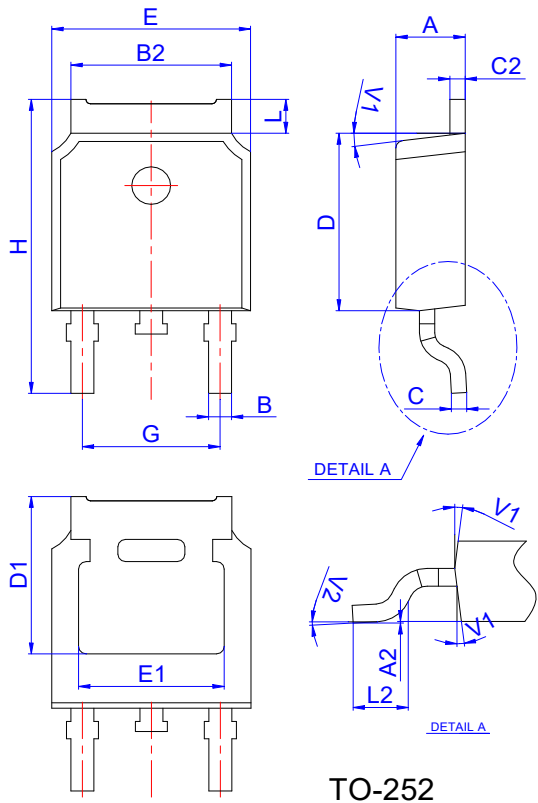


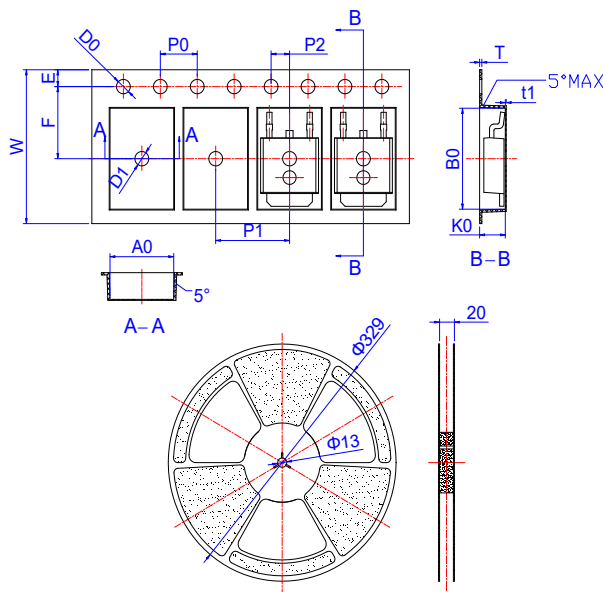
Figure 3:Unclamped Inductive Switching Test Circuit & Waveforms

**Package Mechanical Data-TO-252**



| Ref. | Dimensions  |      |       |          |      |       |
|------|-------------|------|-------|----------|------|-------|
|      | Millimeters |      |       | Inches   |      |       |
|      | Min.        | Typ. | Max.  | Min.     | Typ. | Max.  |
| A    | 2.10        |      | 2.50  | 0.083    |      | 0.098 |
| A2   | 0           |      | 0.10  | 0        |      | 0.004 |
| B    | 0.66        |      | 0.86  | 0.026    |      | 0.034 |
| B2   | 5.18        |      | 5.48  | 0.202    |      | 0.216 |
| C    | 0.40        |      | 0.60  | 0.016    |      | 0.024 |
| C2   | 0.44        |      | 0.58  | 0.017    |      | 0.023 |
| D    | 5.90        |      | 6.30  | 0.232    |      | 0.248 |
| D1   | 5.30REF     |      |       | 0.209REF |      |       |
| E    | 6.40        |      | 6.80  | 0.252    |      | 0.268 |
| E1   | 4.63        |      |       | 0.182    |      |       |
| G    | 4.47        |      | 4.67  | 0.176    |      | 0.184 |
| H    | 9.50        |      | 10.70 | 0.374    |      | 0.421 |
| L    | 1.09        |      | 1.21  | 0.043    |      | 0.048 |
| L2   | 1.35        |      | 1.65  | 0.053    |      | 0.065 |
| V1   |             | 7°   |       |          | 7°   |       |
| V2   |             | 0°   | 6°    |          | 0°   | 6°    |

**Reel Specification-TO-252**



| Ref. | Dimensions  |       |       |        |       |       |
|------|-------------|-------|-------|--------|-------|-------|
|      | Millimeters |       |       | Inches |       |       |
|      | Min.        | Typ.  | Max.  | Min.   | Typ.  | Max.  |
| W    | 15.90       | 16.00 | 16.10 | 0.626  | 0.630 | 0.634 |
| E    | 1.65        | 1.75  | 1.85  | 0.065  | 0.069 | 0.073 |
| F    | 7.40        | 7.50  | 7.60  | 0.291  | 0.295 | 0.299 |
| D0   | 1.40        | 1.50  | 1.60  | 0.055  | 0.059 | 0.063 |
| D1   | 1.40        | 1.50  | 1.60  | 0.055  | 0.059 | 0.063 |
| P0   | 3.90        | 4.00  | 4.10  | 0.154  | 0.157 | 0.161 |
| P1   | 7.90        | 8.00  | 8.10  | 0.311  | 0.315 | 0.319 |
| P2   | 1.90        | 2.00  | 2.10  | 0.075  | 0.079 | 0.083 |
| A0   | 6.85        | 6.90  | 7.00  | 0.270  | 0.271 | 0.276 |
| B0   | 10.45       | 10.50 | 10.60 | 0.411  | 0.413 | 0.417 |
| K0   | 2.68        | 2.78  | 2.88  | 0.105  | 0.109 | 0.113 |
| T    | 0.24        |       | 0.27  | 0.009  |       | 0.011 |
| t1   | 0.10        |       |       | 0.004  |       |       |
| 10P0 | 39.80       | 40.00 | 40.20 | 1.567  | 1.575 | 1.583 |